

SDCL1V30

Semi-shielded power inductors



Product features

- High current carrying capacity
- High power density, low core losses
- Magnetically semi-shielded
- 3.2 mm x 3.2 mm surface mount package in 1.3 mm and 1.5 mm heights
- NiZn ferrite magnetic material
- Moisture sensitivity level (MSL): 1

Applications

- DC-DC converters
- Switching controllers
- Industrial IoT equipment
- Game consoles
- Portable electronics
- Laptops, notebooks, and netbooks
- Desktops and workstations
- Battery backup
- LED lighting
- HD televisions and displays

Environmental compliance and general specifications

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant



Product specifications

Part number ⁵	OCL ¹ (μ H)	FLL ² (μ H) minimum	I _{DC} ³ (A)	I _{pk} ⁴ (A)	DCR (m Ω) @ +20 °C nominal	DCR (m Ω) @ +20 °C maximum
SDCL1V3012						
SDCL1V3012-1R0N-R	1.0 \pm 30%	0.46	1.9	2.0	50	58
SDCL1V3012-1R5N-R	1.5 \pm 30%	0.68	1.5	1.62	57	66
SDCL1V3012-2R2M-R	2.2 \pm 20%	1.14	1.4	1.55	85	105
SDCL1V3012-3R3M-R	3.3 \pm 20%	1.72	0.9	1.05	96	111
SDCL1V3012-4R7M-R	4.7 \pm 20%	2.44	0.8	0.95	135	156
SDCL1V3012-6R8M-R	6.8 \pm 20%	3.54	0.7	0.8	185	213
SDCL1V3012-100M-R	10 \pm 20%	5.2	0.5	0.6	300	345
SDCL1V3012-150M-R	15 \pm 20%	7.8	0.35	0.45	410	471
SDCL1V3012-220M-R	22 \pm 20%	11.44	0.3	0.42	700	805
SDCL1V3012-330M-R	33 \pm 20%	17.16	0.29	0.36	880	1020
SDCL1V3012-470M-R	47 \pm 20%	24.44	0.22	0.27	1500	1750
SDCL1V3012-680M-R	68 \pm 20%	35.36	0.2	0.24	1700	2000
SDCL1V3012-101M-R	100 \pm 20%	52.0	0.15	0.21	2900	3400
SDCL1V3015						
SDCL1V3015-1R0N-R	1.0 \pm 30%	0.46	2.3	2.4	32	38
SDCL1V3015-1R5N-R	1.5 \pm 30%	0.68	2.2	2.3	52	61
SDCL1V3015-2R2M-R	2.2 \pm 20%	1.14	1.8	1.9	66	76
SDCL1V3015-3R3M-R	3.3 \pm 20%	1.72	1.3	1.4	94	109
SDCL1V3015-4R7M-R	4.7 \pm 20%	2.44	1.0	1.1	126	145
SDCL1V3015-6R8M-R	6.8 \pm 20%	3.54	0.8	0.85	180	207
SDCL1V3015-100M-R	10 \pm 20%	5.2	0.7	0.78	270	311
SDCL1V3015-150M-R	15 \pm 20%	7.8	0.6	0.7	340	391
SDCL1V3015-220M-R	22 \pm 20%	11.44	0.45	0.52	500	575
SDCL1V3015-330M-R	33 \pm 20%	17.16	0.4	0.48	860	1000
SDCL1V3015-470M-R	47 \pm 20%	24.44	0.3	0.35	1200	1380
SDCL1V3015-680M-R	68 \pm 20%	35.36	0.25	0.33	2000	2300
SDCL1V3015-101M-R	100 \pm 20%	52	0.22	0.27	2500	2880

1. Open circuit inductance (OCL) test parameters: 100 kHz, 0.25 Vrms, 0.0 Adc, +25 °C

2. Full load inductance (FLL) test parameters: 100 kHz, 0.25 Vrms, I_{DC}, +25 °C

3. I_{DC}: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents.

PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 °C under worst case operating conditions verified in the end application.

4. I_{pk}: Peak current for approximately 35% maximum rolloff @ +25 °C

5. Part number definition: SDCL1Vxxx-yyyz-R

SDCL1V = Product code

xxx= size code

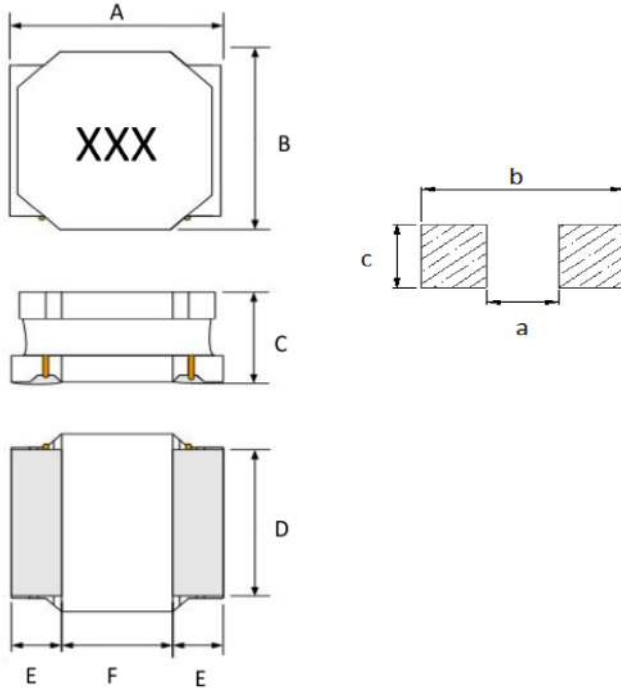
yyy= Inductance value in μ H, R=decimal point

z= Inductance tolerance

-R suffix = RoHS compliant

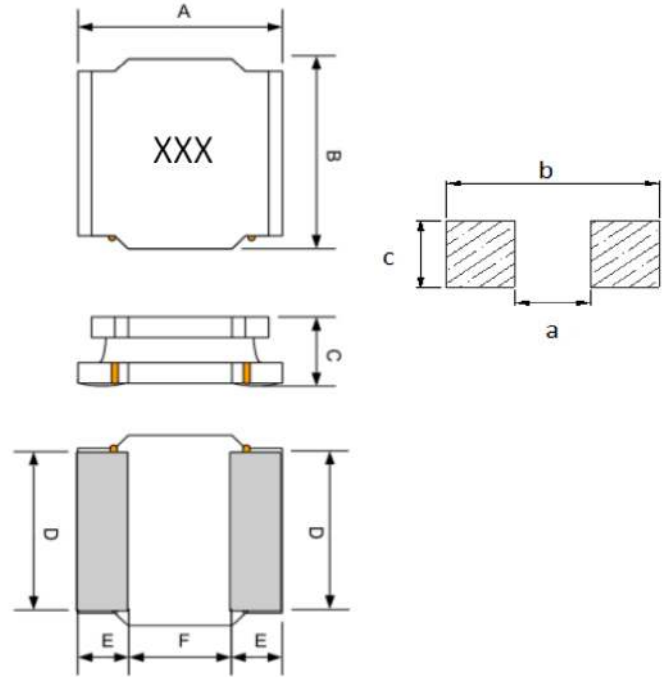
Dimensions-mm

SDCL1V3012



Dimension	Value
A	3.0 + 0.2
B	3.0 + 0.2
C	1.3 maximum
D	2.8 ± 0.2
E	0.9 ± 0.3
F	1.2 ± 0.3
a	0.9 TYP
b	3.3 TYP
c	3.1 TYP

SDCL1V3015



Dimension	Value
A	3.0 + 0.2
B	3.0 + 0.2
C	1.5 maximum
D	2.78 ± 0.2
E	0.9 ± 0.3
F	1.2 ± 0.3
a	0.9 TYP
b	3.3 TYP
c	3.08 TYP

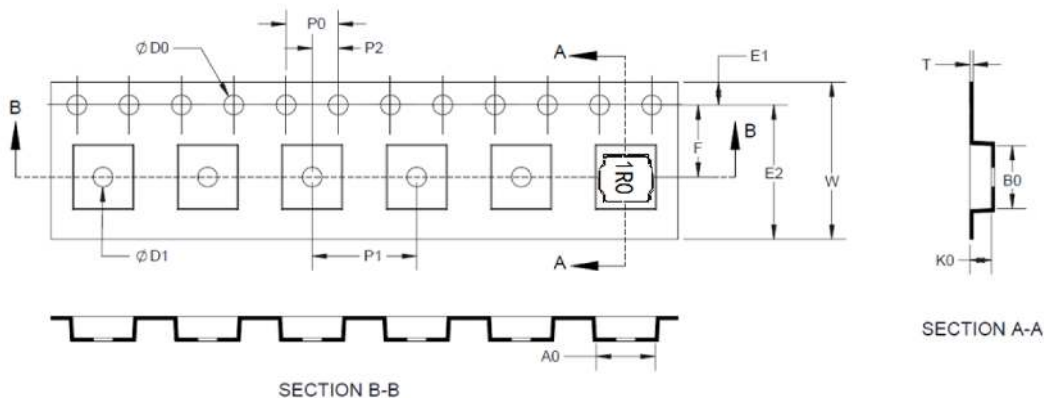
Part marking: xxx= inductance value in uH, R= decimal point. If no R is present then last character equals number of zeros.
Tolerances are ±0.3 millimeters unless stated otherwise
All soldering surfaces to be coplanar within 0.1 millimeters
Pad layout tolerances are ±0.1 millimeters unless stated otherwise
Traces or vias underneath the inductor is not recommended

Packaging information- mm

SDCL1V3012

Supplied in tape and reel packaging, 2000 parts per 7" diameter reel (EIA-481 compliant)

Drawing not to scale



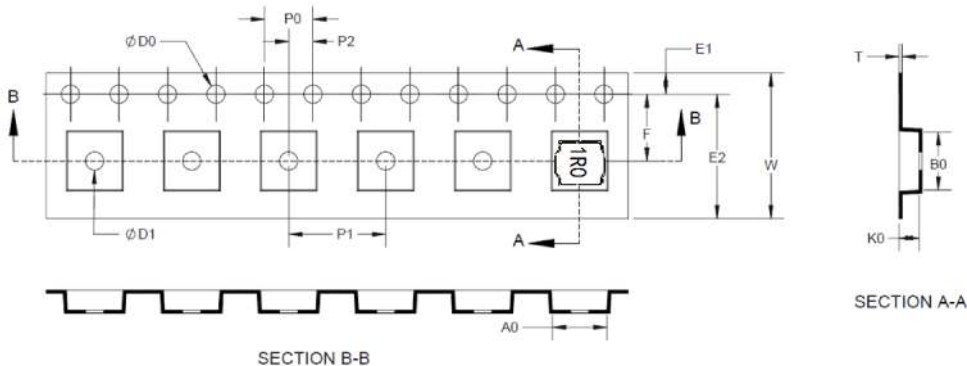
Dimension	Value
W	8.00 ± 0.10
F	3.50 ± 0.05
E1	1.75 ± 0.10
E2	N/A
P0	4.00 ± 0.10
P1	4.00 ± 0.10
P2	2.00 ± 0.10
ØD0	1.55 ± 0.05
ØD1	1.00 ± 0.05
A0	3.30 ± 0.10
B0	3.30 ± 0.10
K0	1.40 ± 0.10
T	0.23 ± 0.05

Packaging information- mm

SDCL1V3015

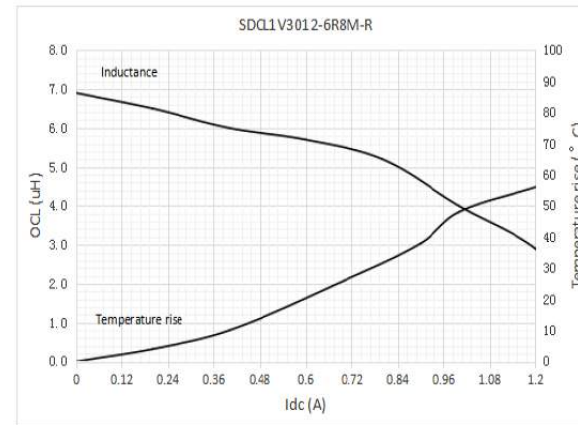
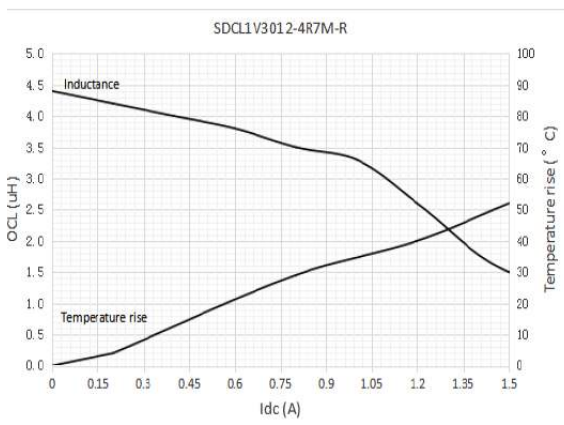
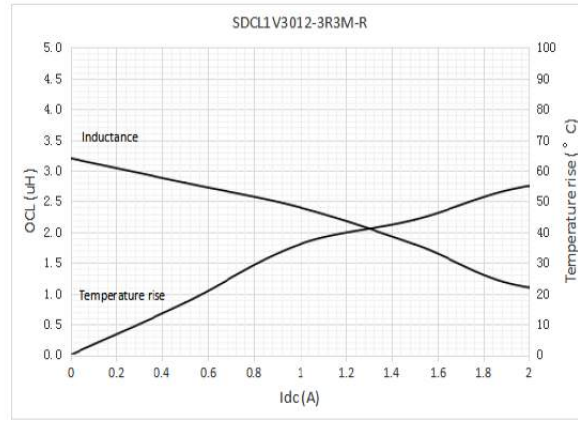
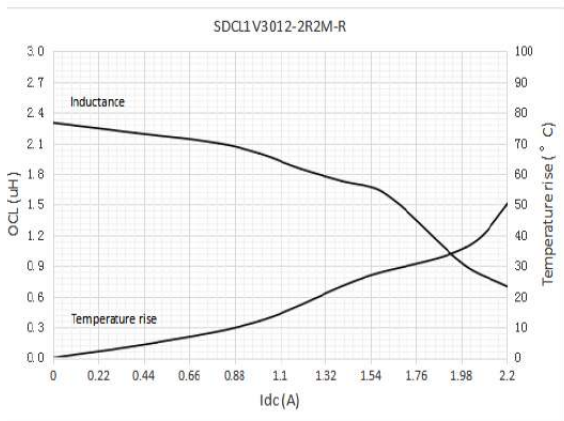
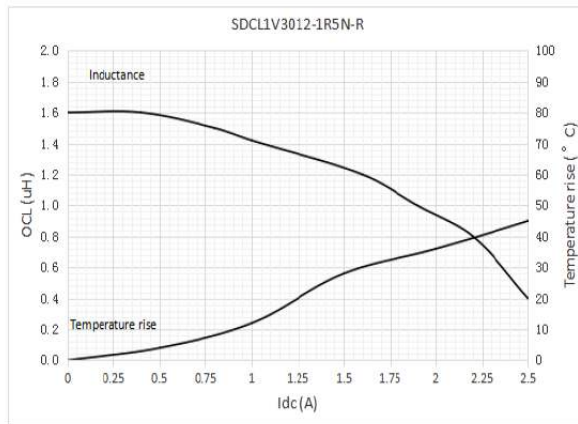
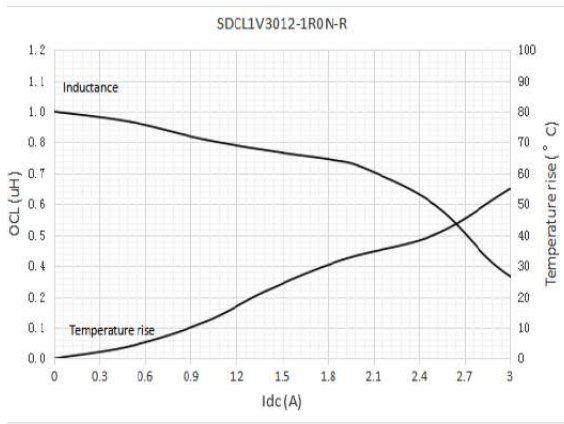
Supplied in tape and reel packaging, 2000 parts per 7" diameter reel (EIA-481 compliant)

Drawing not to scale

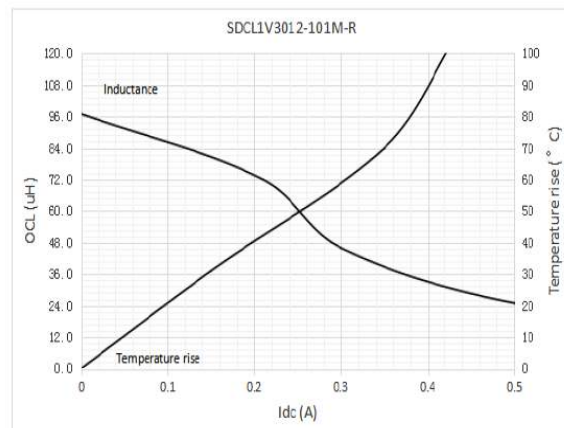
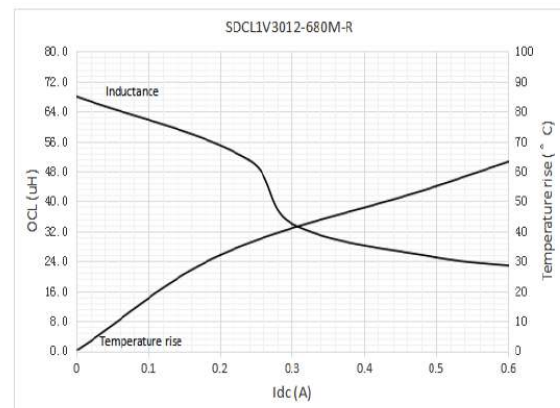
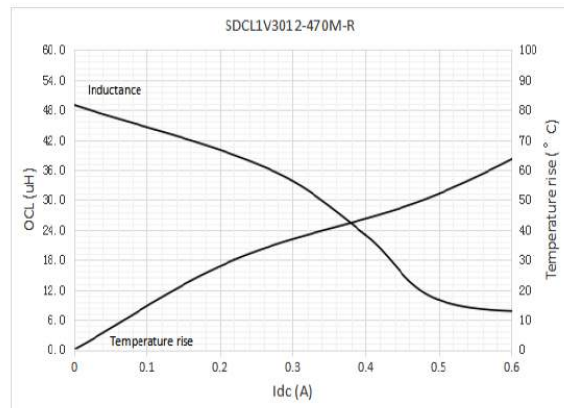
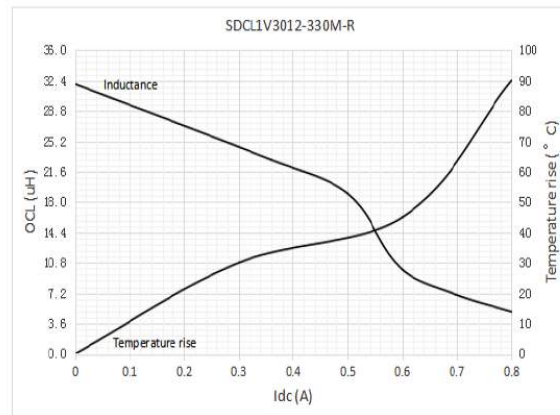
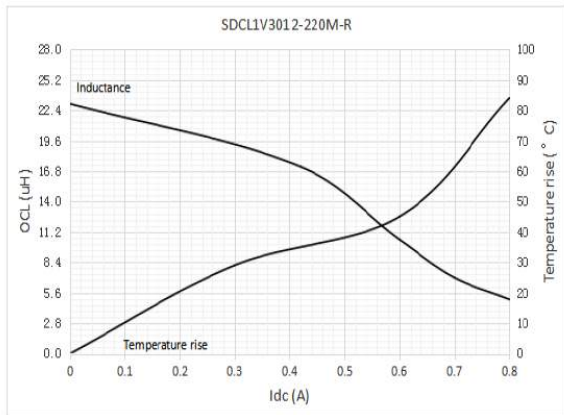
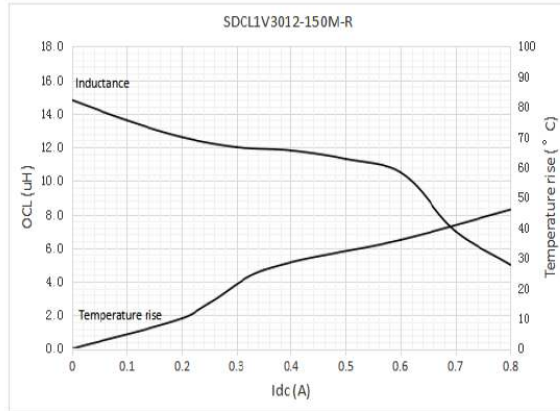
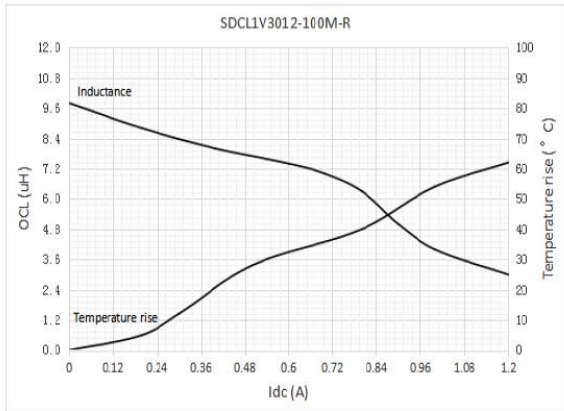


Dimension	Value
W	8.00 ± 0.10
F	3.50 ± 0.05
E1	1.75 ± 0.10
E2	N/A
P0	4.00 ± 0.10
P1	4.00 ± 0.10
P2	2.00 ± 0.10
ØD0	1.55 ± 0.05
ØD1	N/A
A0	3.20 ± 0.05/-0
B0	3.20 ± 0.05/-0
K0	1.70 ± 0.10
T	0.28 ± 0.05

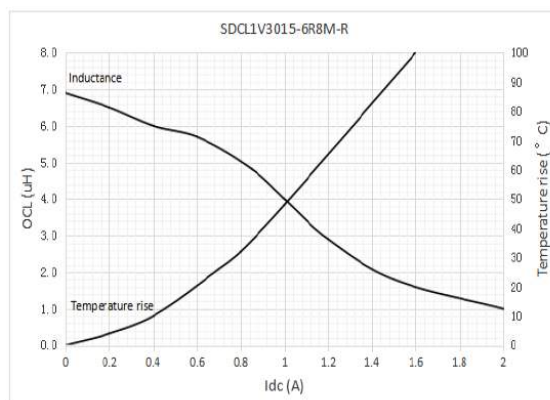
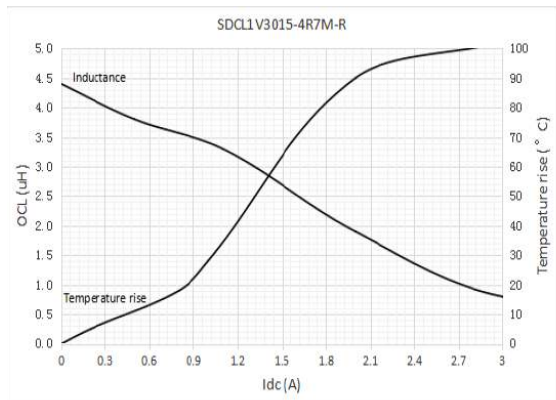
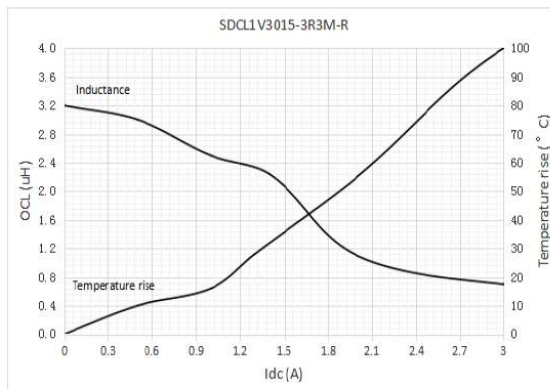
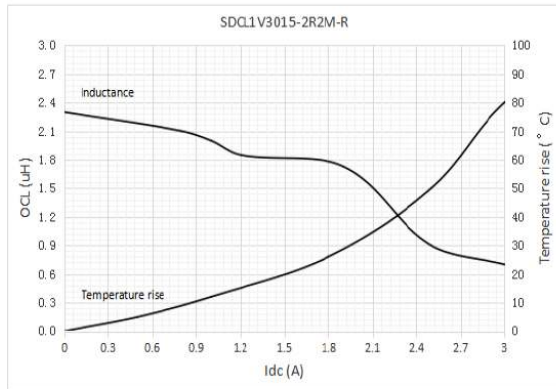
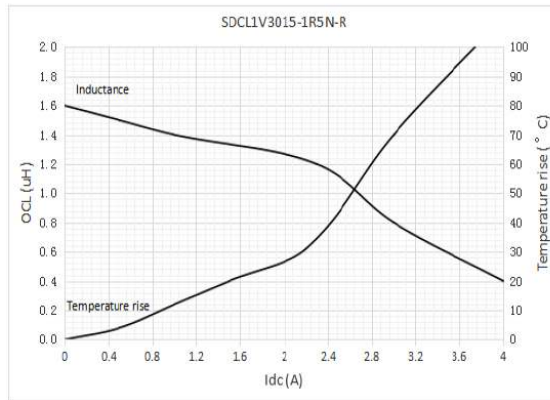
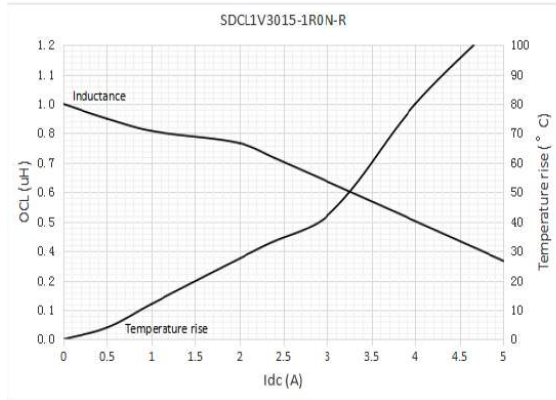
Inductance and temperature rise vs current
SDCL1V3012



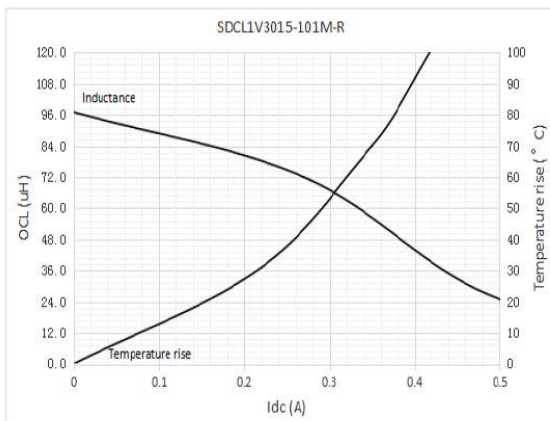
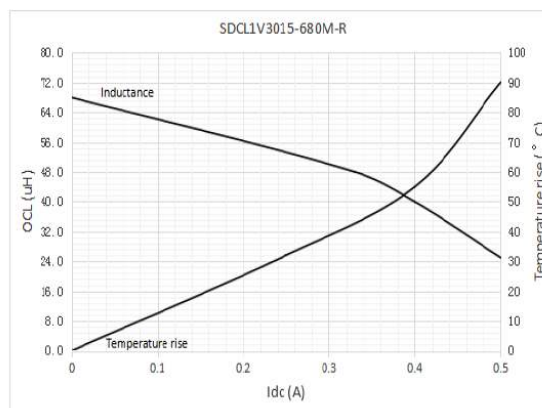
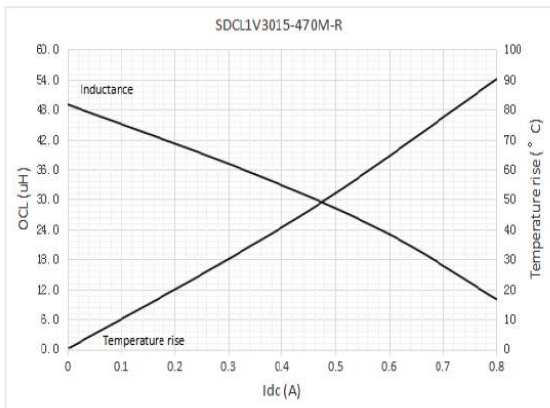
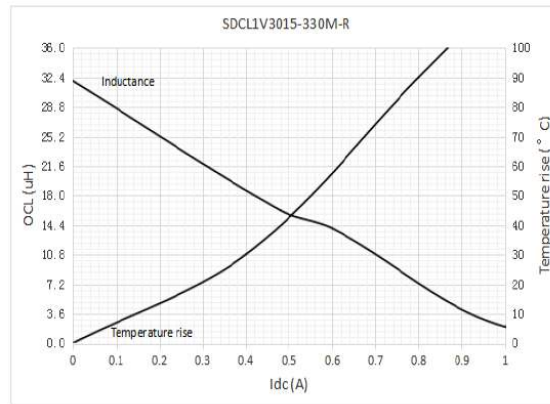
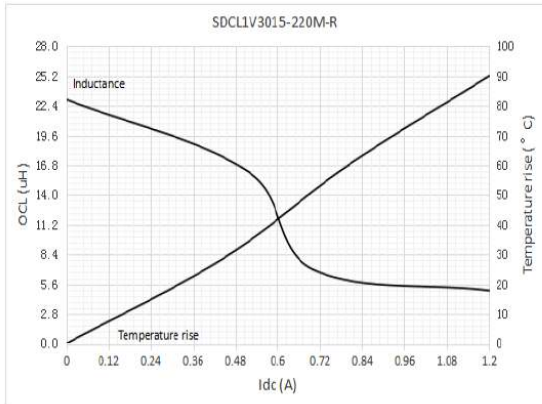
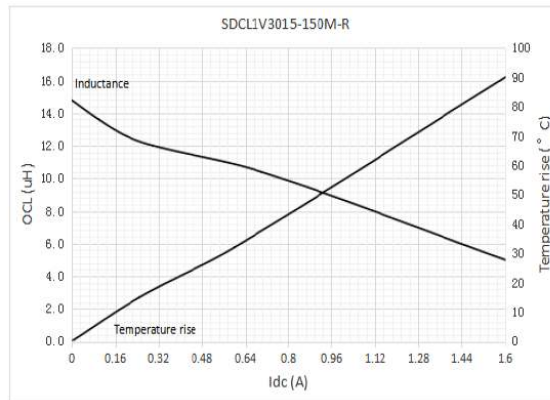
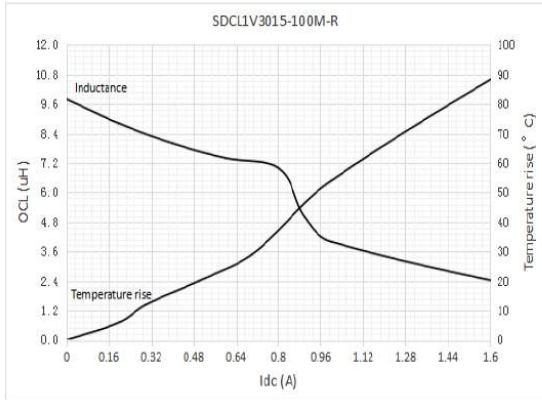
Inductance and temperature rise vs current
SDCL1V3012



Inductance and temperature rise vs current
SDCL1V3015



Inductance and temperature rise vs current
SDCL1V3015



Solder reflow profile

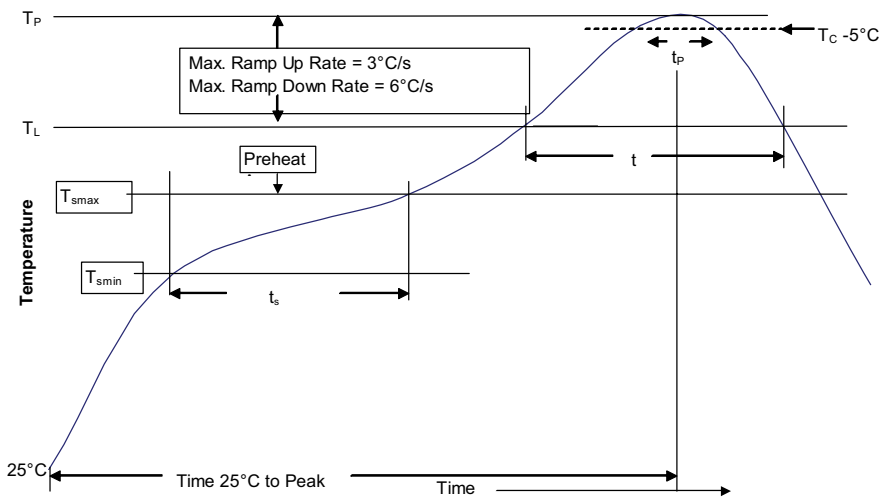


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T _L to T _p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T _L)	183 °C	217 °C
Time (t _L) maintained above T _L	60-150 seconds	60-150 seconds
Peak package body temperature (T _p)*	Table 1	Table 2
Time (t _p)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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